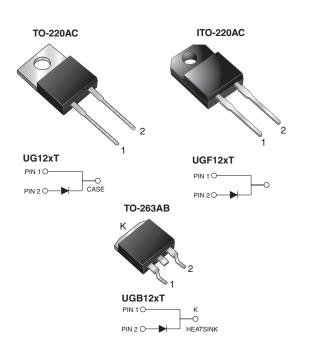
UG12xT, UGF12xT, UGB12xT

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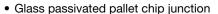
High Voltage Ultrafast Rectifier



PRIMARY CHARACTERISTICS				
I _{F(AV)}	12 A			
V_{RRM}	500 V to 600 V			
I _{FSM}	135 A			
t _{rr}	30 ns			
V _F at I _F = 12 A	1.5 V			
T _J max.	150 °C			
Package	TO-220AC, ITO-220AC, TO-263AB			
Diode variation	Single die			

FEATURES

Power pack



- · Ultrafast recovery time
- · Soft recovery characteristics
- Low switching losses, high efficiency

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- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C (for TO-263AB package)
- Solder dip 275 °C max., 10 s per JESD 22-B106 (for TO-220AC and ITO-220AC package)
- AEC-Q101 qualified
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high voltage and high frequency power factor correction, freewheeling diodes and secondary DC/DC rectification application.

MECHANICAL DATA

Case: TO-220AC, ITO-220AC, TO-263AB

Molding compound meets UL 94V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade Base P/NHE3 - RoHS-compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD22-B102

E3 suffix meets JESD 201 class 1A whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: As marked

Mounting Torque: 10 in-lbs max.

MAXIMUM RATINGS (T _C = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	UG12HT	UG12JT	UNIT		
Max. repetitive peak reverse voltage	V_{RRM}	500	600	V		
Max. working reverse voltage	V_{RWM}	400	480	V		
Max. RMS voltage	V _{RMS}	350	420	V		
Max. DC blocking voltage	V _{DC}	500	600	V		
Max. average forward rectified current (fig. 1)	I _{F(AV)}	12		А		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	135		А		
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150		°C		
Isolation voltage (ITO-220AC only) from terminals to heatsink t = 1 min	V _{AC}	1500		V		

UG12xT, UGF12xT, UGB12xT

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ELECTRICAL CHARACTERISTICS (T _C = 25 °C unless otherwise noted)						
PARAMETER	TEST	TEST CONDITIONS		UG12HT	UG12JT	UNIT
Max. instantaneous forward voltage (1)	I _F = 12 A	2 A T _J = 25 °C		1.75		V
	I _F = 12 A	T _J = 125 °C	V _F	1.50		V
Max. reverse current		T _J = 25 °C		30		μA
		T _J = 125 °C	— I _R	4.0		mA
May reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 0.25 \text{ A}$	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		30		ns
Max. reverse recovery time	'	$I_F = 1.0 \text{ A, dl/dt} = 50 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } I_{rr} = 0.1 I_{RM}$		5	0	ns
Typical softness factor (t _b /t _a)		$I_F = 12 \text{ A}, \text{ dI/dt} = 240 \text{ A/}\mu\text{s}, $ $V_R = 400 \text{ V}, I_{rr} = 0.1 I_{RM}$		0	.9	-
Max. reverse recovery current		I _F = 12 A, dI/dt = 96 A/μs, V _R = 400 V, T _C = 125 °C		7	.5	Α
Peak forward recovery time		I _F = 12 A, dI/dt = 96 A/μs, V _F = 1.1 V x V _F max.		50	00	ns

Note

 $^{^{(1)}\,}$ Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _C = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	UG12	UGF12	UGB12	UNIT	
Typical thermal resistance from junction to case	$R_{ heta JC}$	1.73	3.04	1.73	°C/W	

ORDERING INFORMATION (Example)						
PACKAGE	PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
TO-220AC	UG12JT-E3/45	1.80	45	50/tube	Tube	
ITO-220AC	UGF12JT-E3/45	1.95	45	50/tube	Tube	
TO-263AB	UGB12JT-E3/45	1.33	45	50/tube	Tube	
TO-263AB	UGB12JT-E3/81	1.33	81	800/reel	Tape and reel	
TO-220AC	UG12JTHE3/45 (1)	1.80	45	50/tube	Tube	
ITO-220AC	UGF12JTHE3/45 (1)	1.95	45	50/tube	Tube	
TO-263AB	UGB12JTHE3/45 (1)	1.33	45	50/tube	Tube	
TO-263AB	UGB12JTHE3/81 (1)	1.33	81	800/reel	Tape and reel	

Note

⁽¹⁾ AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

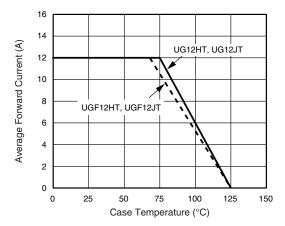
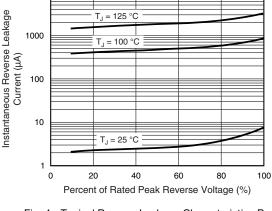


Fig. 1 - Forward Current Derating Curve



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Fig. 4 - Typical Reverse Leakage Characteristics Per Leg

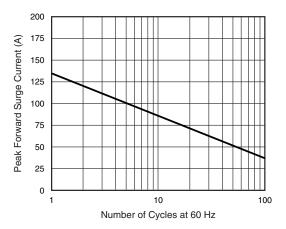


Fig. 2 - Max. Non-Repetitive Peak Forward Surge Current

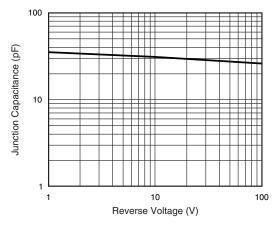


Fig. 5 - Typical Junction Capacitance Per Leg

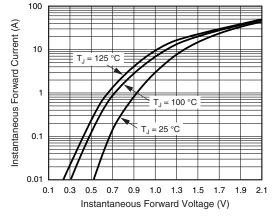


Fig. 3 - Typical Instantaneous Forward Characteristics Per Leg

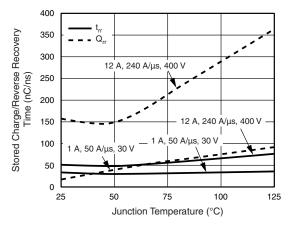


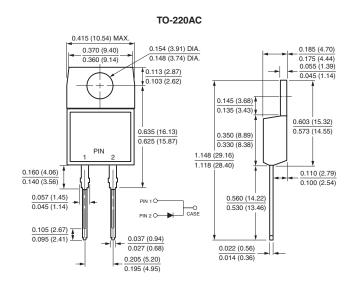
Fig. 6 - Reverse Switching Characteristics Per Leg

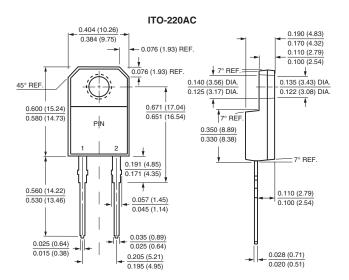


UG12xT, UGF12xT, UGB12xT

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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





TO-263AB 0.411 (10.45) 0.190 (4.83) 0.380 (9.65) 0.160 (4.06) 0.055 (1.40) 0.245 (6.22) 0.045 (1.14) MIN. 0.055 (1.40) 0.360 (9.14) 0.047 (1.19) 0.320 (8.13) 0.624 (15.85) Κ 2 0.591 (15.00) -0 to 0.01 (0 to 0.254) 0.110 (2.79) 0.090 (2.29) 0.037 (0.940) 0.021 (0.53) 0.027 (0.686) 0.014 (0.36) 0.105 (2.67) 0.140 (3.56) 0.095 (2.41) 0.205 (5.20) 0.110 (2.79) 0.195 (4.95)

0.42 (10.66) MIN. 0.33 (8.38) MIN. 0.670 (17.02) 0.591 (15.00) 0.15 (3.81) MIN.

0.105 (2.67)

0.095 (2.41)

Mounting Pad Layout



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